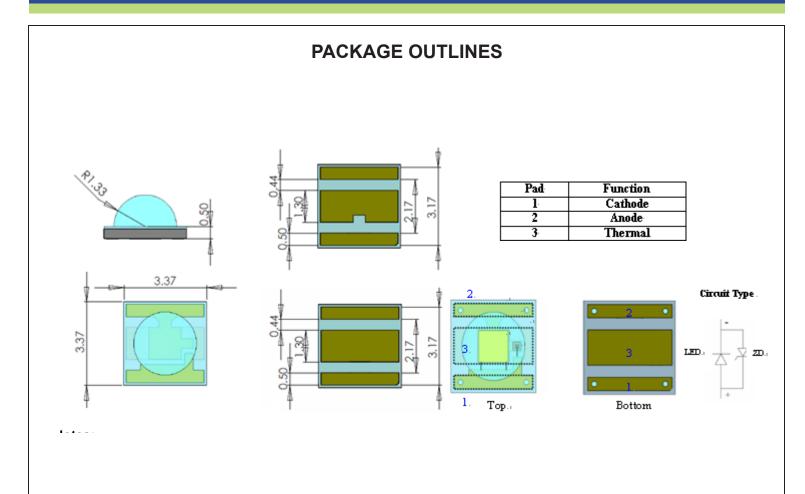


## **SPECIFICATIONS**

# CSHU33WW2ZC



#### Notes:

- 1. All dimensions are in millimeter (inches).
- 2. Tolerance is  $\pm$  0.25mm (0.01") unless otherwised noted.
- 3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
CSHU33WW2ZC	InGaN	Warm White	Water Clear	120°





## **ABSOLUTE MAXIMUM RATINGS**

(TA=25°C)

Parameter	Symbol	Max Rating	Unit
Forward Current	lF	500	mA
ESD Threshold (HBM)	V	2000	V
Reverse Voltage	V	5	V
Junction Temperature	TJ	125	°C
Operating Temperature Range	Тор	-40~+100	°C
Storage Temperature Range	Тѕтс	-40~+100	°C
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	-	mA
Soldering Temperature	Tsol	Max 260°C for 5 sec Max	

## **OPTICAL-ELECTRICAL CHARACTERISTICS**

(TA=25°C)

Parameter	Symbol	Test Condition	Value			Linit
Parameter			Min	Тур	Max	Unit
CCT Range	X	IF = 350mA	-	0.43	-	-
CCT Range	Y	IF = 350mA	1	0.40	1	ı
Reverse Leakage Current	lR	V <sub>R</sub> = 12V	1	-	1	μA
Forward Voltage	VF	IF = 350mA	-	3.4	3.75	٧
Luminous Intensity	lv	IF = 350mA	60	74	-	lm

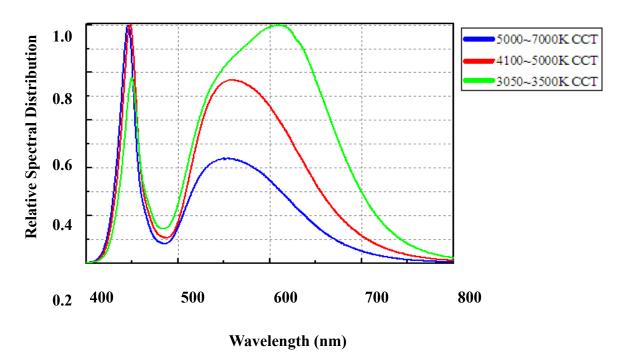
<sup>\*</sup>Tolerance of viewing angle: -10 / +5 deg.



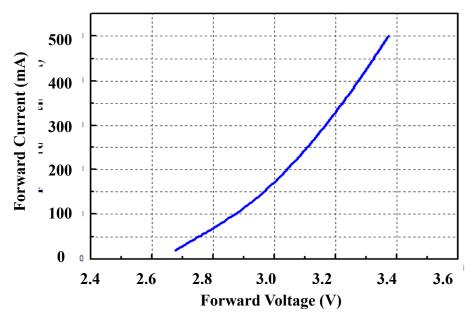


### **RELATIVE SPECTRAL CHARACTERISTICS & ELECTRICAL CHARACTERISTICS**

### Relative Spectral Characteristics, Tj=25°C, I<sub>F</sub>=350mA



## Typical Electrical Characteristics, Tj=25<sup>0</sup>C



ROHS
Compliant
Orde

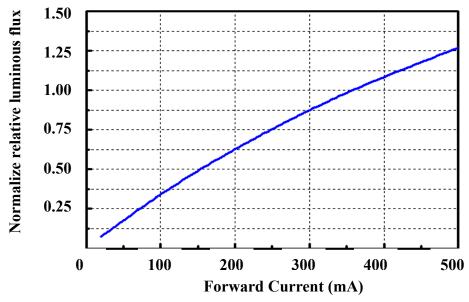
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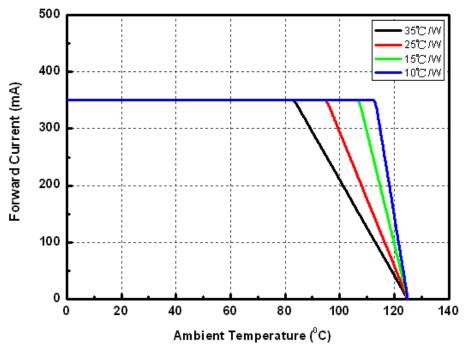


## **OPTICAL CHARACTERISTIC CURVES**

# Typical Relative Luminous Flux vs. Forward Current, Tj=25°C



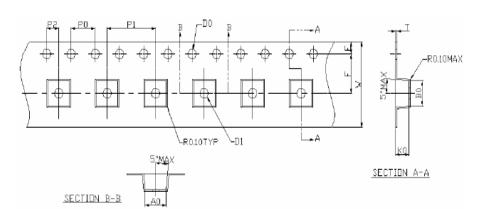
### Current Derating Curve, I<sub>F</sub>=350mA



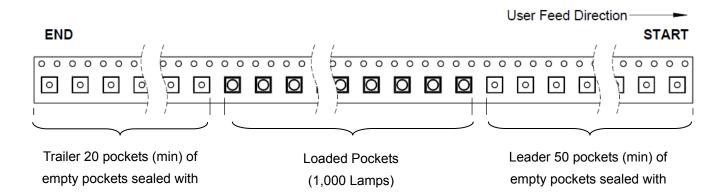
RoHS ChromeLED order to support of this documents

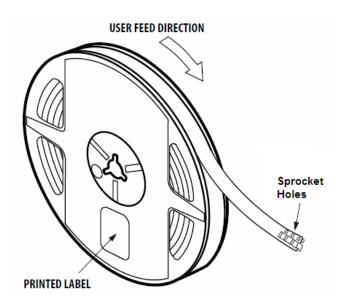


# TAPING ORIENTATION



Item	Specification	Tol. (+/-)
W	12.00	± 0.30
E	1.75	± 0.10
F	5.50	± 0.10
D0	1.50	+0.10, -0
D1	1.50	± 0.10
P0	4.00	± 0.10
P1	8.00	± 0.10
P2	2.00	± 0.10
P0 x 10	40.00	± 0.20
t	0.30	± 0.05
A0	3.80	± 0.10
В0	3.80	± 0.10
K0	2.20	± 0.10





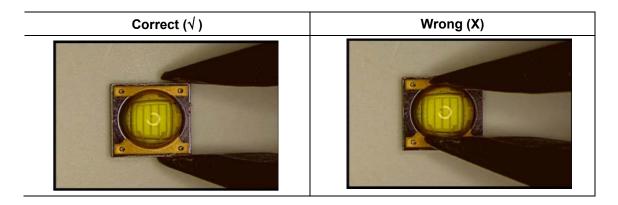


## **LENS HANDLING**

#### Lens handling

Please follow the guideline to grab LEDs

- Use tweezers to grab LEDs
- Do not touch lens with the tweezers
- Do not touch lens with fingers
- Do not apply more than 4N of lens (400g) directly onto the lens



#### Lens cleaning

In the case where a minimal level of dirt and dust particles can not be guaranteed, a suitable cleaning solution can be applied to the lens surface

- Try a gentle swabbing using a lint-free swab
- If needed, the use of lint-free swab and isopropyl alcohol used gently removes dirt from the lens surface
- Do not use other solvents as they may directly react with the LED assembly
- Do not use ultrasonic cleaning that the LED will be damaged







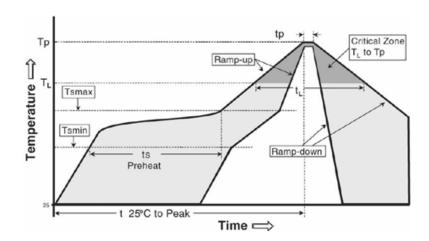






# **SOLDERING CONDITIONS**

### Reflow soldering conditions



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (Tsmax to Tp)	3° C/second max.	3° C/second max.
Preheat   - Temperature Min (Ts <sub>min</sub> )   - Temperature Max (Ts <sub>max</sub> )   - Time (Ts <sub>min</sub> to Ts <sub>max</sub> ) (ts)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-180 seconds
Time maintained above: - Temperature (T <sub>L</sub> ) - Time (t <sub>L</sub> )	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak Temperature (Tp)	215 °C	260 °C
Time within 5°C of actual Peak Temperature (tp) <sup>2</sup>	10-30 seconds	20-40 seconds
Ramp-down Rate	6 °C/second max.	6 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

